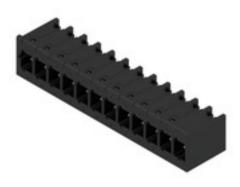


Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image

















Configurable connector portfolio with fast and safe SNAP IN connection technology. The modular slice concept allows different hybrid combinations out of signal, data and power in one. The future-proof system is suitable for the highest requirements of the digital and connected world.

General ordering data

Order No.	<u>2741510000</u>
Туре	MHS 5/12 H T3 B T
GTIN (EAN)	4064675055488
Qty.	8 Stück
Product data	IEC: 400 V / 26.8 A UL: 300 V / 18.5 A
Packaging	Tube



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Technische Daten

Dimensions and weights

Depth	14 mm	Depth (inches)	0.551 inch
Height	15.1 mm	Height (inches)	0.594 inch
Height of lowest version	11.9 mm	Net weight	9.522 g
Weight	9.41 g	Width	61.4 mm
Width (inches)	2.417 inch		

System specifications

Type of connection		Mounting onto the PCB	THT/THR solder
	Board connection	_	connection
Pitch in mm (P)	5 mm	Pitch in inches (P)	0.197 inch
Outgoing elbow	90°	Number of poles	12
Number of solder pins per pole	1	Solder pin length (I)	3.2 mm
Solder pin dimensions	1.0 x 1.0 mm	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerand	e (D)+ 0,1 mm	Outside diameter of solder pad	2.3 mm
Template aperture diameter	2.1 mm	L1 in mm	55 mm
L1 in inches	2.165 inch	Number of rows	1
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	Touch-safe above the printed circuit board
Touch-safe protection acc. to DIN VI	DE	Volume resistance	
0470	IP 20		≤5 mΩ
Plugging force/pole, max.	8.5 N	Pulling force/pole, max.	8.5 N

Material data

Insulating material	PA 9T	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	I
Comparative Tracking Index (CTI)	≥ 600	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact base material	CuMg
Contact material	CuMg	Contact surface	tinned
Tinning type		Layer structure of solder connection	13 μm Ni / 24 μm Sn
	matt		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt		-25 °C
Storage temperature, max.	55 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	26.8 A
Rated current, max. number of poles (Tu=20°C)	19.7 A	Rated current, min. number of poles (Tu=40°C)	23.1 A
Rated current, max. number of poles (Tu=40°C)	16.9 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		



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Technische Daten

Rated data acc. to UL 1059

nstitute (cURus)	(ii)	Certificate No. (cURus)	
	. L II		
	C TABLE IIS		F00000
	<u> </u>		E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are		
	maximum values, details -		
	see approval certificate.		
Classifications			
TIM 6.0	EC002637	ETIM 7.0	EC002637
CLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
CLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Rated current related to rated cross-section & min. No. of poles.
	• P on drawing = pitch
	 Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
	Diameter of solder eyelet D = 1.4+0.1mm

Approvals

Approvals	c Al s	
UL File Number Search	E60693	
Downloads		
Engineering Data	<u>STEP</u>	



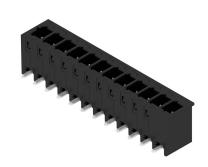
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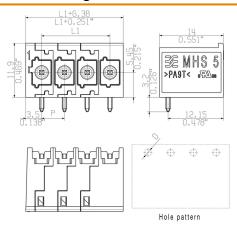
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Zeichnungen

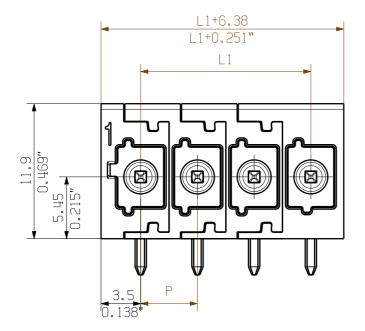
Product image

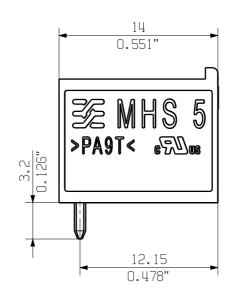


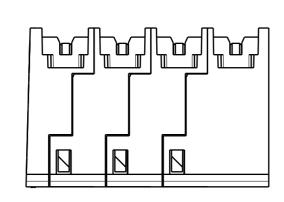
Dimensional drawing

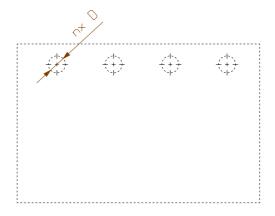


Allgemeingueltige Kundenzeichnung, aktueller Stand nur auf Anfrage General customer drawing, topical version only if required







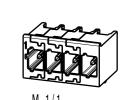


Hole pattern

Further Dim. & Info. See data sheet

General tolerance: DIN ISO 2768-mK

Drawings Assembly



9	40.00	1.575
8	35.00	1.378
7	30.00	1.181
6	25.00	0.984
5	20.00	0.787
4	15.00	0.591
3	10.00	0.394
2	5.00	0.197
n Poles	L1 [mm]	L1 [inch]

55.00 2.165

45.00 | 1.772

50.00

1.969

5111 100	- 1 0 0 mm							Poles	[[m m]	[[incn]
	EC00004370				Prim PLM	Part No.: .	Prim	ERP Part No.	: .	
ROMS	P028441 First Issue Date		Max. nos		We	idmüller	Z,	72562	2	4 Issue no.
	07.05.2020		Modifi	cation				Sheet 3	of 4	sheets
	\Box			Date	Name					
			Drawn	03.12.2020	Tauber-Reglin,		MHS 5/	Τą		
			Responsible		Schmitz, Till		STIFTLE			
Scale: 3/	1 Size:	A 3	Approved	15.01.2021	Sapina, Svetos		MALE HE			

Product file:

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components $\,$

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmueller PCB components are tested according to the DIN EN 61984 or to the DIN EN 60947-7-4 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

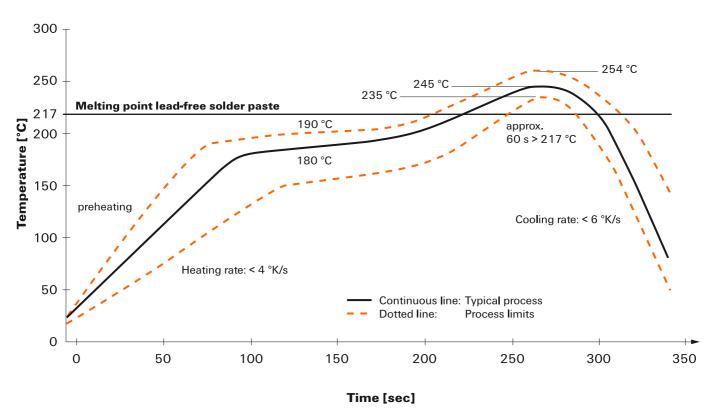


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +4$ K/s. In parallel the solder paste is ,activated. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.



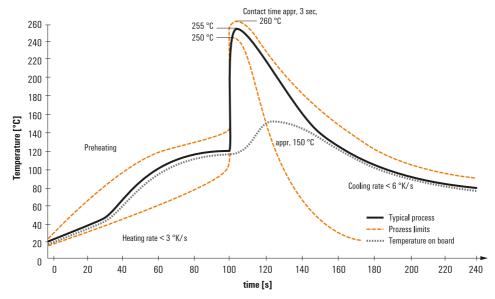
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

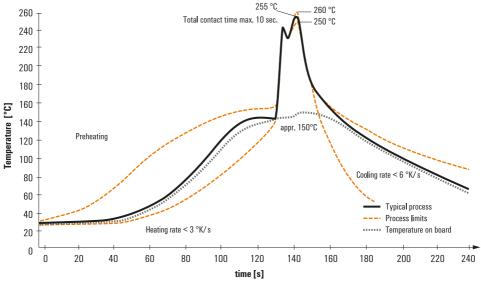
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.